

## DEVELOPMENT DATA

This data sheet contains advance information and specifications are subject to change without notice.

BGY91A

## UHF POWER AMPLIFIER MODULE

A UHF amplifier module primarily designed for mobile communications equipment, operating directly from 12.5 V electrical systems. The module will produce a minimum output of 6 W into a 50  $\Omega$  load over the frequency range of 806 to 890 MHz.

The module consists of a three-stage RF amplifier using npn transistor chips with lumped-element matching components in a plastic stripline encapsulation. The negative supply is internally connected to the flange.

### QUICK REFERENCE DATA

Mode of operation		CW
Frequency range		806 to 890 MHz
DC supply voltage	$V_{S1}, V_{S2}, V_{S3}$	nom. 12.5 V
Drive power	$P_D$	max. 30 mW
Load power	$P_L$	> 6.0 W
Input, output impedance	$z_i, Z_L$	nom. 50 $\Omega$

### MECHANICAL DATA

Dimensions in mm

#### Pinning:

- 1 = RF input
- 2 =  $V_{S1}$
- 3 =  $V_{S2}$
- 4 =  $V_{S3}$
- 5 = RF output

Flange connected to earth.

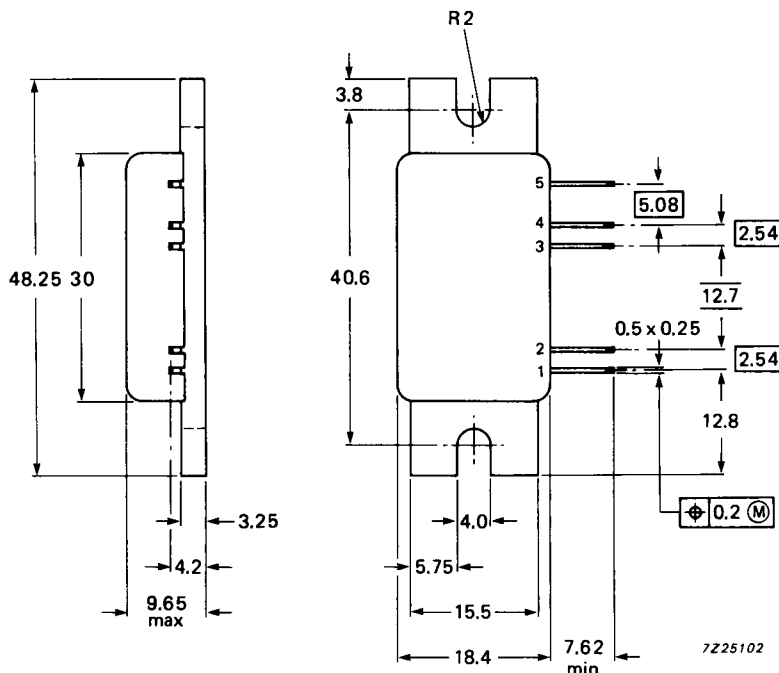


Fig. 1 SOT-233.

**PRODUCT SAFETY** This device incorporates beryllium oxide (BeO), the dust of which is toxic. The device is entirely safe provided that the internal BeO disc is not damaged.

## RATINGS

Limiting values in according with the Absolute Maximum System (IEC 134)

DC supply terminal voltages *	$V_{S1}, V_{S2}, V_{S3}$	max.	16 V
RF input terminal voltage *	$\pm V_i$	max.	25 V
RF output terminal voltage *	$\pm V_o$	max.	25 V
Load power	$P_L$	max.	8.0 W
Drive power	$P_D$	max.	80 mW
Storage temperature range	$T_{stg}$		-40 to + 100 °C
Operating heatsink temperature range	$T_h$		-30 to + 90 °C

## CHARACTERISTICS

$T_h = 25\text{ °C}$ ;  $V_{S1} = V_{S2} = V_{S3} = 12.5\text{ V}$ ;  $R_S = R_L = 50\text{ }\Omega$ ;  $f = 806\text{ to }890\text{ MHz}$  unless otherwise stated.

Quiescent currents

$P_D = 0$	$I_{Q1}$	typ.	10 mA
	$I_{Q2}$	typ.	80 mA

RF drive power

$P_L = 6\text{ W}$	$P_D$	<	30 mW
		typ.	20 mW

Efficiency

$P_L = 6\text{ W}$	$\eta$	>	30 %
		typ.	35 %

Harmonic output

any harmonic (relative to carrier); $P_L = 6\text{ W}$		<	-35 dB
		typ.	-40 dB

Input VSWR

with respect to $50\text{ }\Omega$	VSWR	max.	2.0 : 1
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## Stability

The module is stable with load VSWR up to 4 (all phases) when operated within the following conditions:

$V_{S2} = V_{S3} = 10\text{ to }16\text{ V}$ ;  $f = 806\text{ to }890\text{ MHz}$ ;  $P_D = 0\text{ to }40\text{ mW}$ ;  $V_{S1} = 0\text{ to }12.5\text{ V}$ ;  $P_L < 8\text{ W}$  (matched).

## Ruggedness

The module will withstand a load VSWR of 50 : 1 for short period overload conditions, with  $P_D$ ,  $V_{S1}$ ,  $V_{S2}$  and  $V_{S3}$  at maximum values, providing the combination does not result in the matched RF output power derating curve being exceeded ( $T_h < 90\text{ °C}$ ).

## Mounting

To ensure good thermal transfer the module should be mounted onto a heatsink with a flat surface and heat-conducting compound applied between module and heatsink. Burrs and thickening of the heatsink should be removed and 3 mm bolts tightened to a torque of 0.5 Nm. The leads of the devices may be soldered directly into a circuit using a soldering iron with a maximum temperature of 245 °C for not more than 10 seconds at a distance of at least 1 mm from the plastic.

\* With respect to flange.

**Power rating**

In general it is recommended that the output power from the module under nominal conditions should not exceed 7 W in order to provide an adequate safety margin under fault conditions.

**Gain control**

Power output can be controlled by variation of the driver stage supply voltage  $V_{S1}$  from 0.5 V to 12.5 V.

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